Photonics and Laser Material Processing for Solar Energy Systems at Fraunhofer ISE



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EPIC Online Technology Meeting on Solar Energy Systems

June 26th 2020

www.ise.fraunhofer.de

Fraunhofer ISE

Fields of Research



ISE: Institute for Solar Energy Systems

Staff: ≈ 1200

Budget 2019: € 102.6 million (preliminary)

Established: 1981

Prof Dr Hans-Martin Henning

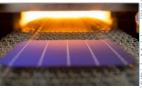
Prof. Dr. Hans-Martin Henning

PHOTOVOLTAICS
Dr. Andreas Bett

Energy Efficient Buildings



Silicon Photovoltaics



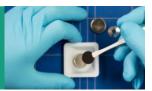
Solar Thermal Power Plants and Industrial Processes



III-V and Concentrator Photovoltaics



Hydrogen Technologies and Electrical Energy Storage



Emerging Photovoltaic Technologies



Power Electronics, Grids and Smart Systems



Photovoltaic Modules and Power Plants



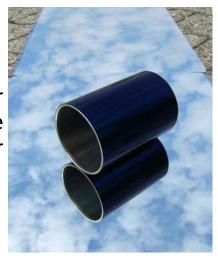
Other Photonics Technologies @ ISE

Portofolio of Group Coating Technology and Systems CTS

Solutions based on functional vacuum coatings

- Solar thermal power generation
- Energy efficiency
- Photovoltaics
- Fuel cells and H₂ generation

thermal solar receiver tube and mirror





Colored PV modules



Facade with low-E



Optically-switchable glazing

Other Photonics Technologies @ ISE

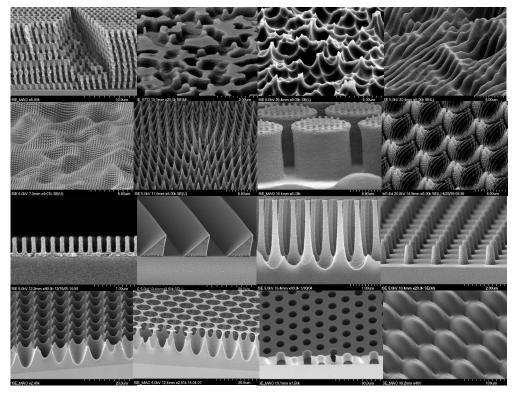
Fabrication of Photonic Structureswith Interference Lithography

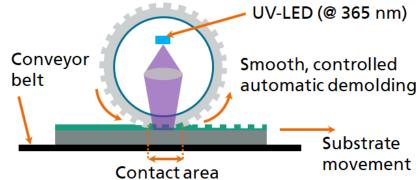
- Maximum substrate size: 1.2 x 1.2 m²
- Seamless structures over full area
- Exposure times: up to 5 h
- Optical path lengths: up to 20 m
- Acceptable instabilities: < 20 nm</p>
- Extreme stability requirements for building and set-up



Other Photonics Technologies @ ISE Nanoimprint Lithography

- UV-exposure throughout flexible stamp (e.g. PDMS)
- Imprinted area: 156 x 156 mm²
- Excellent adaptability to rough surfaces
- Homogeneous and low residual layer thickness (< 100 nm)
- Successfully tested on very thin wafer substrates (50 µm)

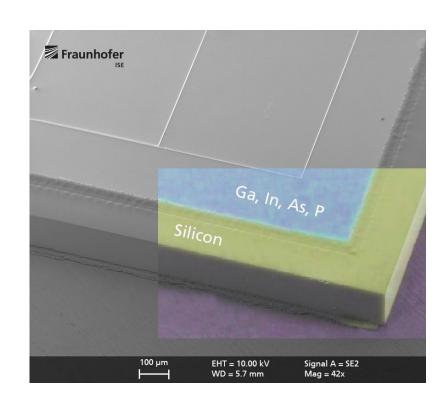


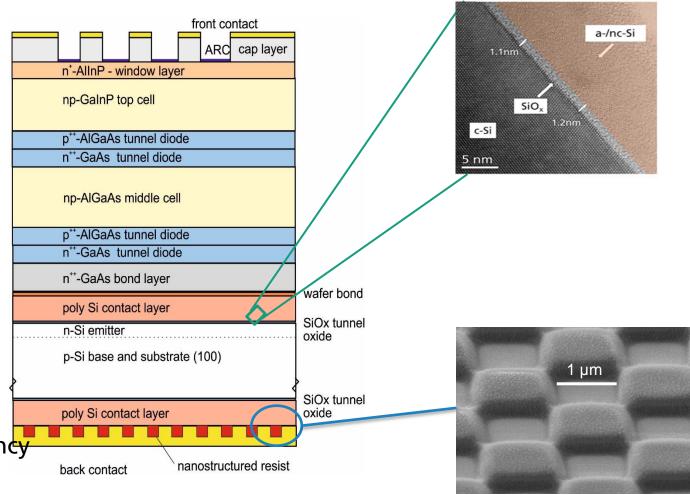




III-V/Si Triple-Junction Solar Cells (2-Terminal)

Rear Side TOPCon with Nanostructured Grating





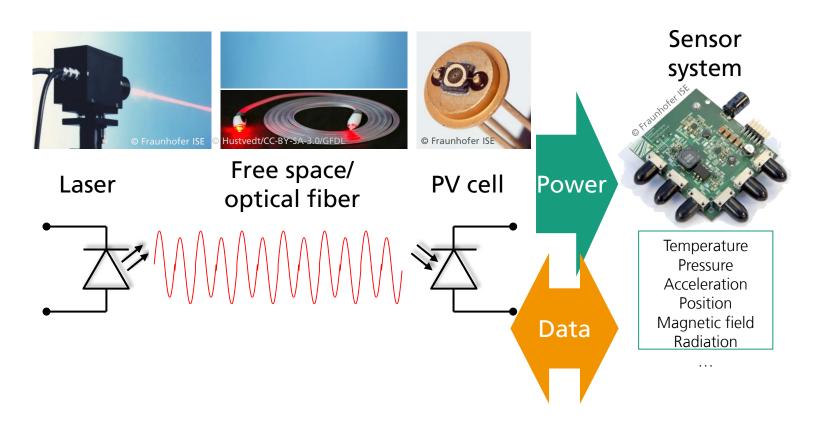
4.8 µm of III-V material enable an efficiency increase from 26.7%* to 34.1% (AM1.5g)

* Best Si solar cell according to M.A. Green et al. "Solar cell efficiency tables (Version 55)", Prog. In PV, 2019



Other Photonics Technologies @ ISE

Optical Power Supply & Bidirectional Communication in Purely Optical Channel





Electromagnetic interference



Wireless power



Galvanic isolation



Lightning protection



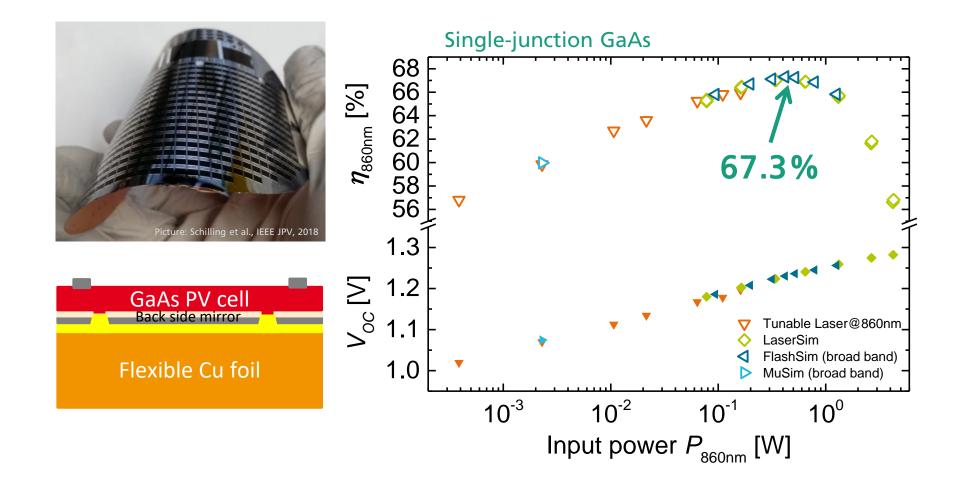
Explosion protection



Weight reduction

Other Photonics Technologies @ ISE

Photovoltaic Laser Power Converter: GaAs Cells under Monochromatic Light

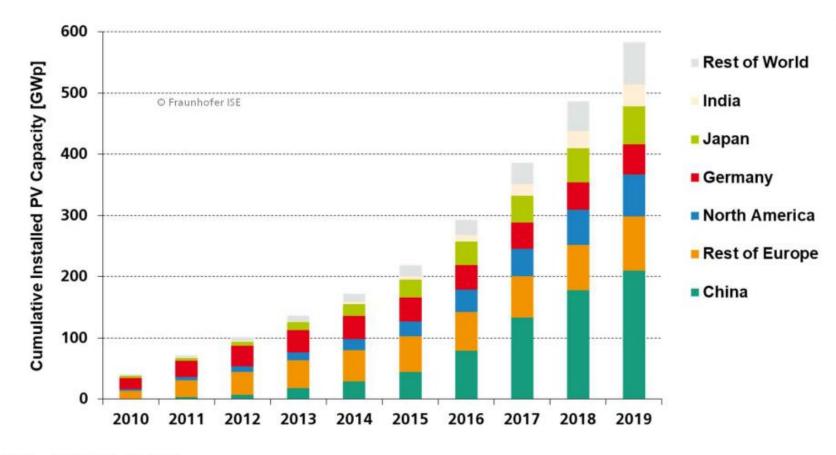




Photovoltaics Market Overview

PV Production by Technology

Percentage of Global Annual Production

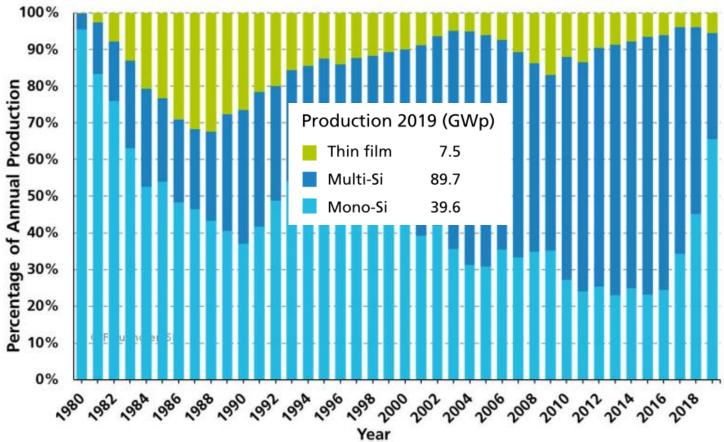


The share of off-grid installations decreased by time; from about 1% in year 2010 to about 0.6% in year 2019.

Data: IRENA 2020. Graph: PSE Projects GmbH 2020

Dominance of Wafer Based Solar Cells

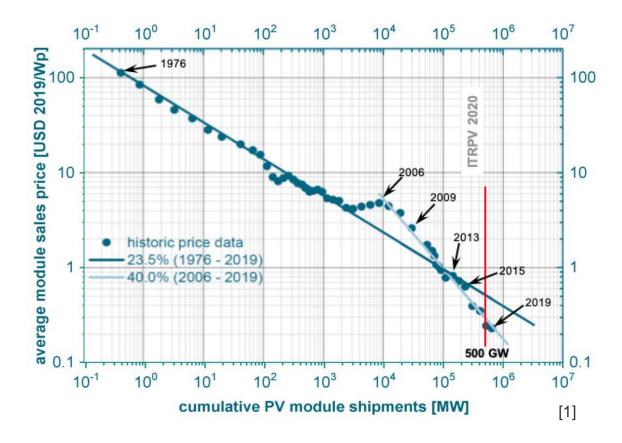
- Wafer based crystalline silicon solar cells dominate > 90% of the production volume
- Thin-film technology with less than 5% market share



Data: from 2000 to 2010: Navigant; from 2011: IHS (Mono-/Multi- proportion from cell production). Graph: PSE GmbH 2018

Price Learning Curve as Function of Cumulative Shipments – ,Swanson's law'

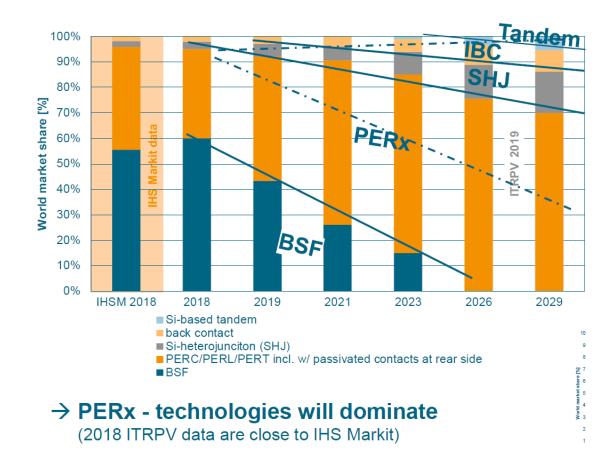
Learning curve for module price as a function of cumulative shipments



Device Type Trends

- Wafer based crystalline solar cells dominate > 90% of the production volume
- Thin Film technology with less than 5% market share
- PERC production in 2018 included around 1000 laser processing machines for laser contact opening alone

Trend: share of cell technologies





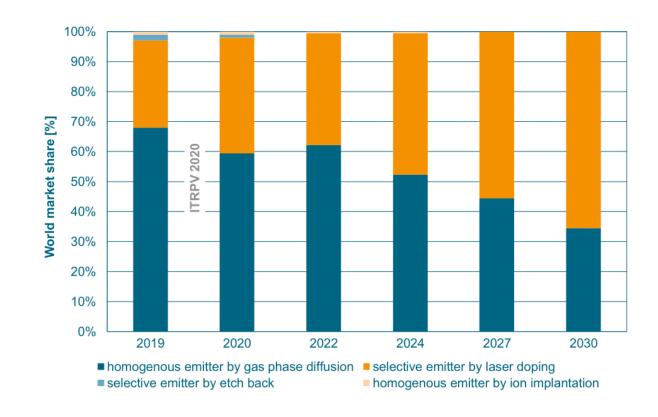




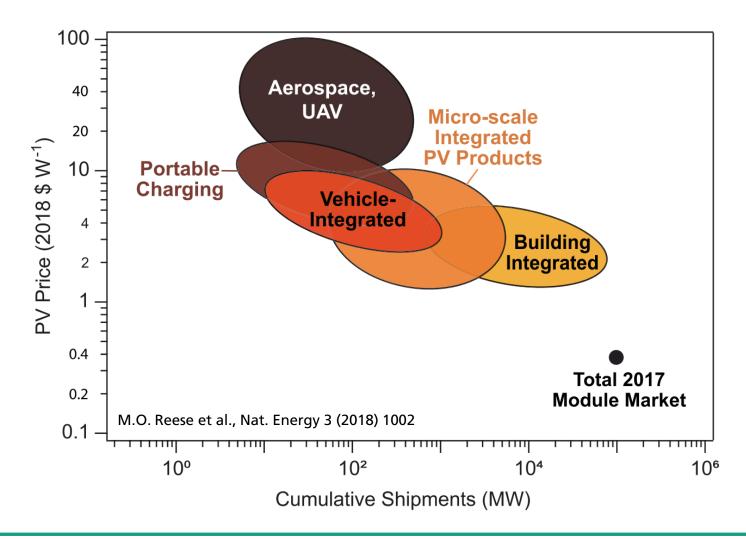
Widespread Adoption of Laser Doping in PERC Production Expected

Second laser process that is due to increase market penetration after nanosecond laser contact opening is already the de facto standard for PERC solar cells

Different phosphorous emitter technologies for p-type cells



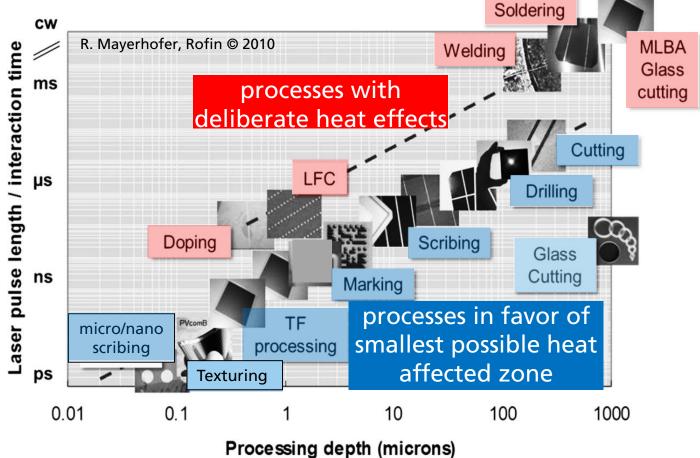
Specialized Applications



Laser Material Processing in Photovoltaic Manufacturing

Applications in Photovoltaics

- Many laser processes in PV production came and went
 - Laser edge isolation
 - > replaced by chemical etching
 - → might reappear
 - Via drilling
 - → never mass adopted
 - Laser fired contacts (LFC) for PERC
 - → replaced by laser contact opening (LCO)

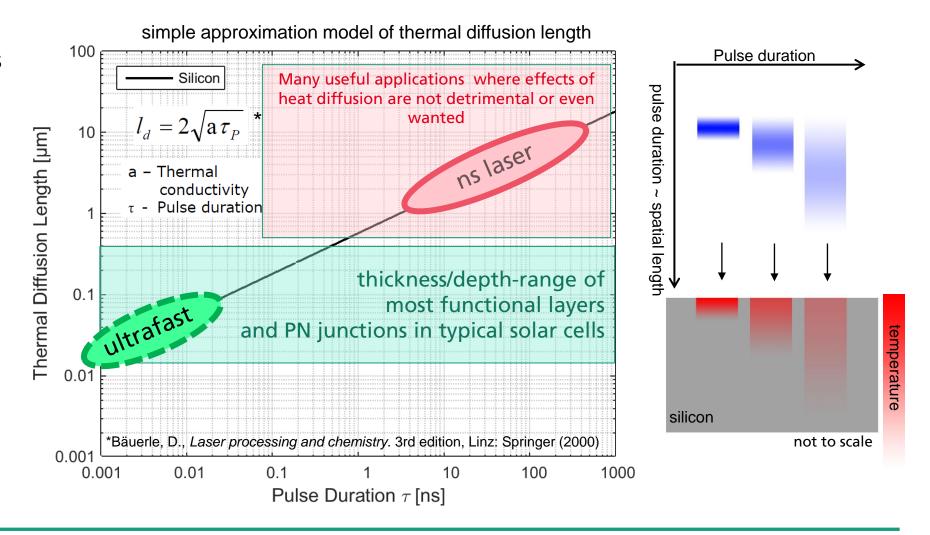


Laser Material Processing for Crystalline Silicon Solar Cells - Background -

Laser Processes for Crystalline Silicon Solar Cells

Thermal Diffusion Length

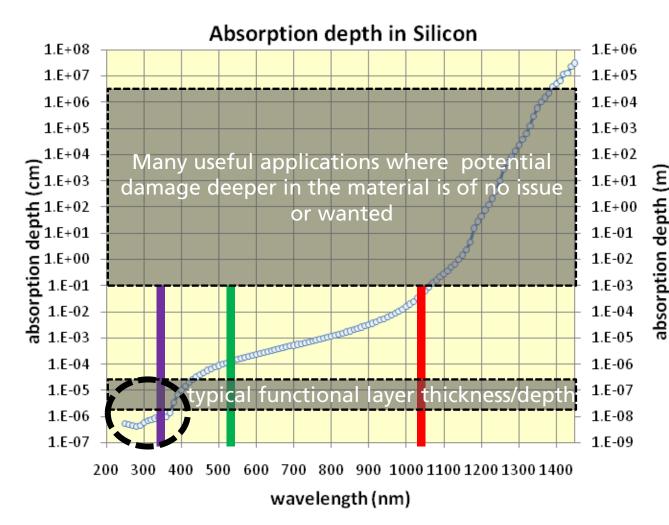
 ultrashort laser pulses enable selective structuring without affecting underlying layers thermally

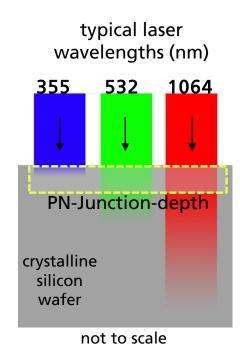


Laser Processes for Crystalline Silicon Solar Cells

Optical Absorption Depth

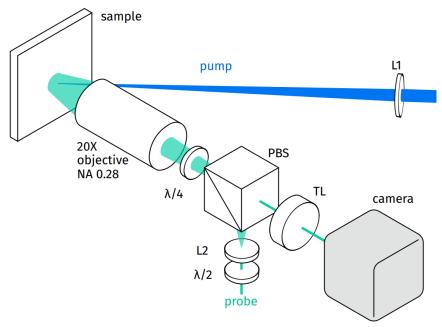
- ultrashort laser
 pulses enable
 selective structuring
 without affecting
 underlying layers
 thermally
- only UV provides small enough absorption depth to prevent defects in functional regions like PN-junction depths or passivated contact layer stacks



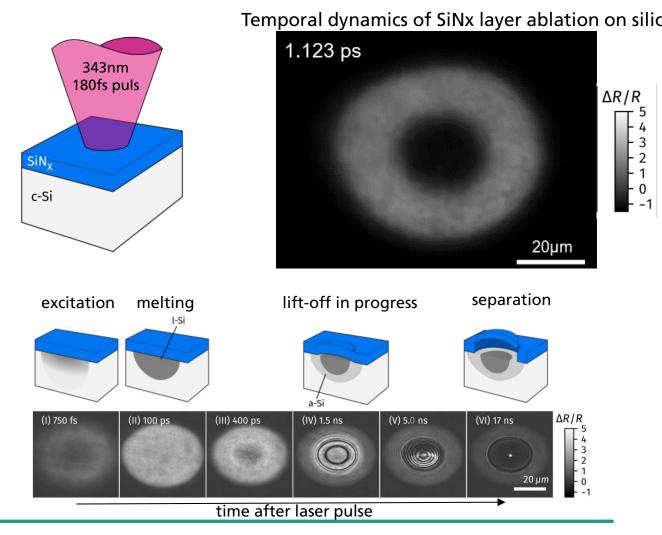


Laser Processes for Crystalline Silicon Solar Cells

Dynamic Analysis of Thin-Film laser ablation via Pump-Probe Microscopy



- Thousands of single images combined deliver a slow motion of the dynamics with an effective framerate of 10¹³
- Provides insight into process dynamics like material removal and resolidification velocities

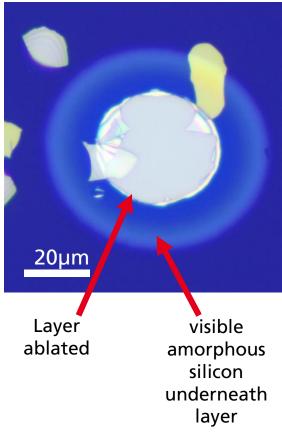


Laser Ablation of Dielectric Layers on Crystalline Silicon

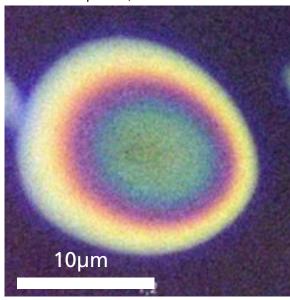
Amorphization of Surface

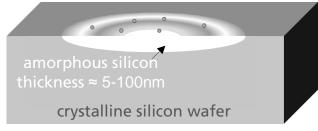
- Highly selective layer ablation without much melting possible with ultrashort pulse lasers
- Cooling rate of molten silicon too fast to recrystallize properly, amorphous silicon remains
- Amorphization also occurs when irradiating bare silicon with ultrashort laser pulses

Optical microscopy image of 70nm SiN_x ablated by 180fs pulse with $\lambda=343$ nm



Optical microscopy image of planar silicon irradiated by 10ps laser pulse, λ =355nm





not to scale

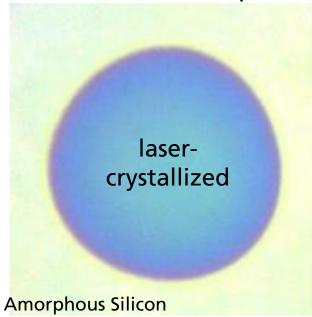


Laser Ablation of Dielectric Layers on Crystalline Silicon

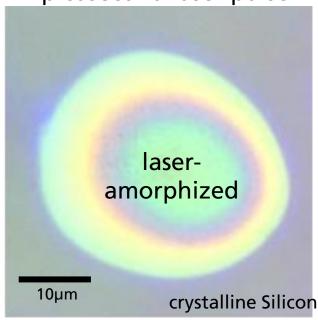
Amorphization vs Crystallization – a matter of pulse duration

- Highly selective layer ablation without much melting possible with ultrashort pulse lasers
- Cooling rate of molten silicon too fast to recrystallize properly, amorphous silicon remains
- Amorphization also occurs when irradiating bare silicon with ultrashort laser pulses
- Pump-Probe reflectometry reveals process dynamics
- Residual crystallinity of silicon drastically affected by laser process dynamics

Crystallizing using nanosecond laser pulse



Amorphization using picosecond laser pulse



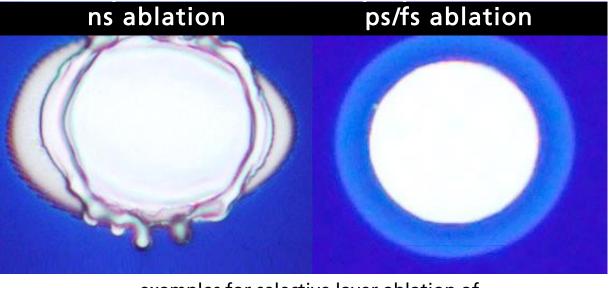
Optical microscopy images

How to achieve ultra-short pulse layer ablation without amorphization?

Laser Ablation of Dielectric Layers on Crystalline Silicon Which Is The Best Process?

Is this always going to be a compromise?

- No amorphization
- Large heat affected zone and melt ejection



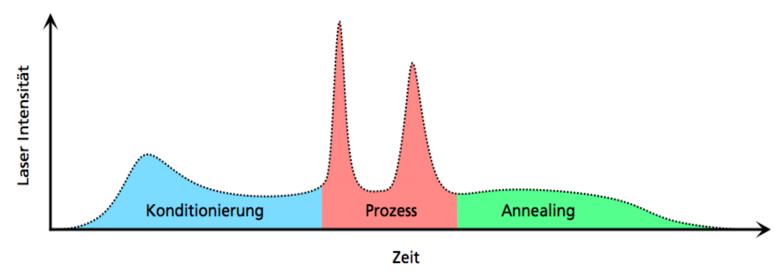
examples for selective layer ablation of transparent SiNx on planar silicon wafer

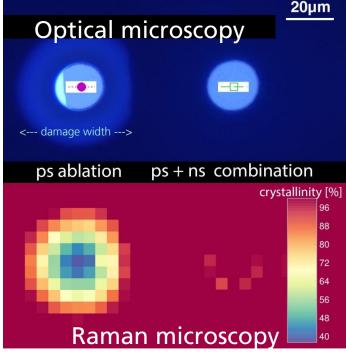
- Residual surface and surrounding area amorphous
- Very shallow heat affected zone of <100nm</p>

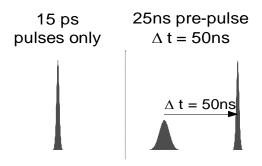
Laser Ablation of Dielectric Layers on Crystalline Silicon

Temporal Pulse Shaping

- Pre-Heating or post-annealing the material can yield a process without amorphization
- A whole new processing regime opening up with temporal pulse shaping





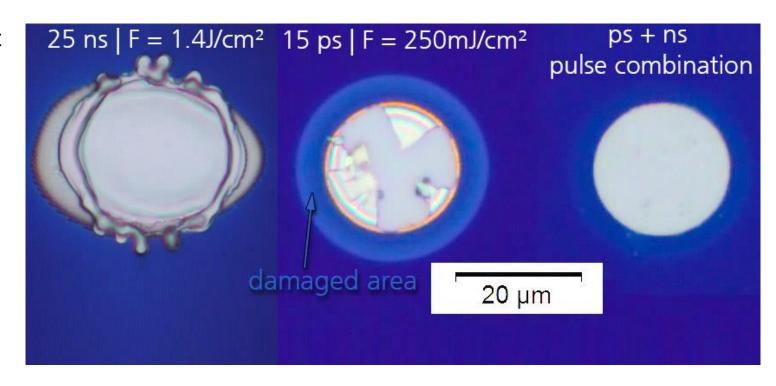




Laser Ablation of Dielectric Layers on Crystalline Silicon

Temporal Pulse Shaping – Pre-Heating

- Pre-Heating or post-annealing the material can yield a process without amorphization
- A whole new processing regime opening up with temporal pulse shaping
- Nanosecond pre-pulse temporarily increases absorption coefficient for VIS and NIR radiation
- Best of short and ultrashort pulse machining possible in 'one process'



Selection of Laser Processes for Crystalline Silicon Solar Cells

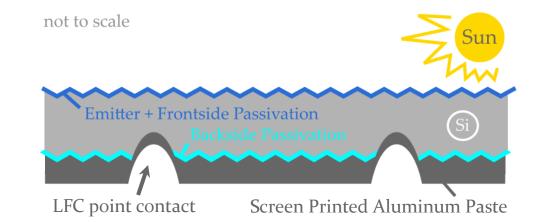
Laser Fired Contacts (LFC) [1]

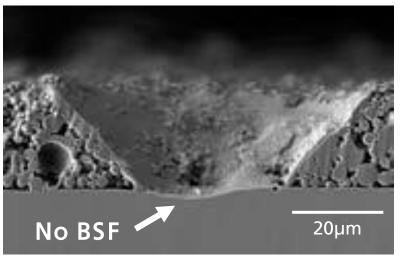
Of Screen Printed Aluminium Rear Side

- First industrial PERC Module by Q Cells featured LFC process invented at Fraunhofer ISE [1]
- Screen printed layer is shot through the passivation
- Advantages of lasers in production processes
 - Reliable + cost effective
 High flexibility
 - Easy application
 Contactless

	V _{oc}	J _{sc}	<i>FF</i>	η	A
	[V]	[A]	[%]	[%]	[cm ²]
Solar Cell	0.652	9.46	76.7	19.50	243

PV parameters of Q Cells large-area solar cell world record.[2]





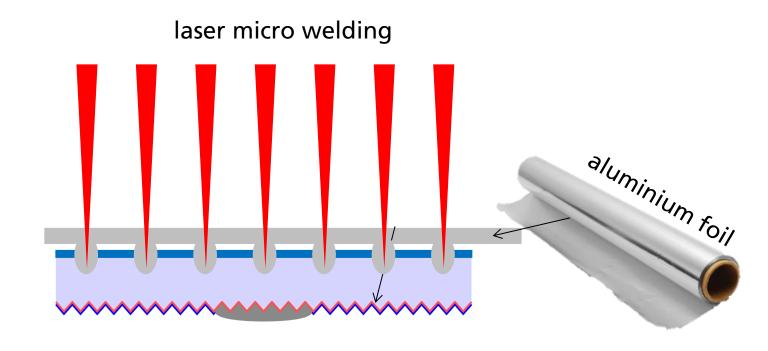
Source: Innovation Award Laser Technology 2014



Laser Fired Contacts using Aluminium Foil (FOLMET)

Process Animation

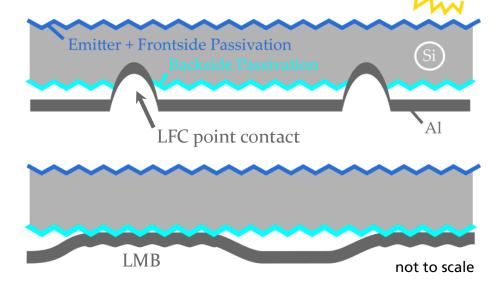
- Passivated Emitter and Rear Cell (PERC) p-type [1]
- Positioning of aluminium foil at the rear side
- Laser fired contacts (LFC) [2] for electrical contact and fixation
- Cutting the foil at the edge of the wafer

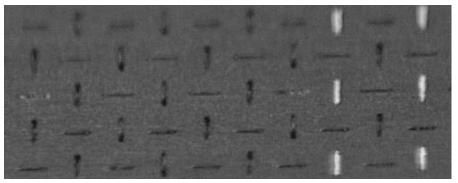


Laser Metal Bonding (LMB)

Adhesion of Aluminium Foil without Affecting the Substrate

- No melting of the substrate material
- Non penetrating, non-ablative → particle free
- Optimization via finite element simulations
- Tunable air-gap between aluminium and substrate for superior optical reflection
- Cost efficient CW Laser source

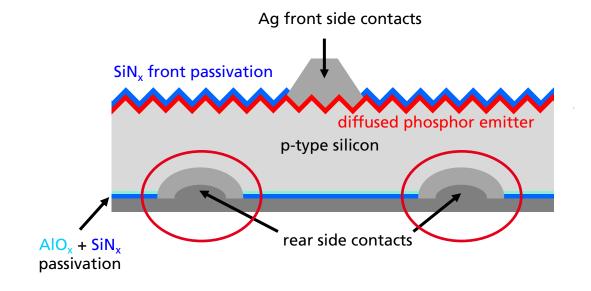


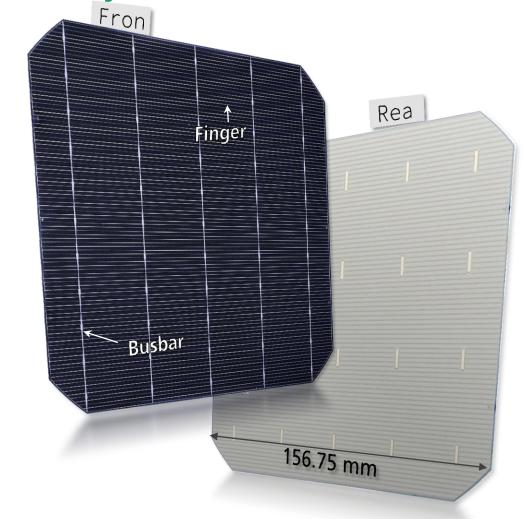


In situ photo of the LMB process, showing a tilted view on the backside aluminum foil surface [5]



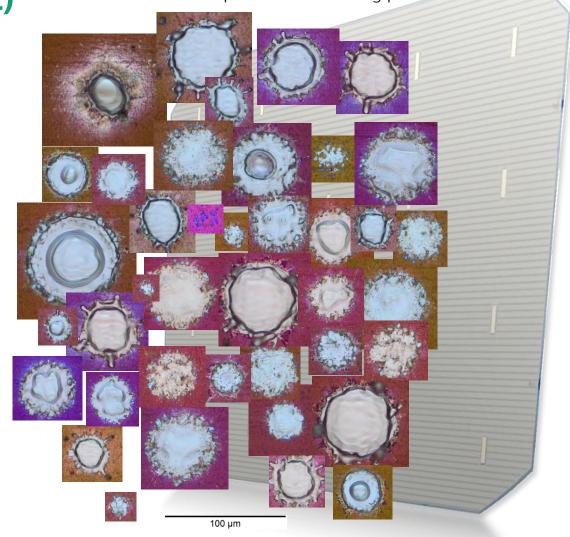
For Local Rear Side Aluminium Contacts of Industry Standard PERC Solar Cells





many functional implementations laser opening that work with For local rear side contacts (p-type PERC) ifferent wafers/aluminium pastes and sintering parameters

- LCO PERC makes up more than 50% of world wide production of standard cells (both sides connected)
- Contact firing eliminates (most) laser damage
- Laser parameters and geometry range widely by manufacturer
- Process mostly implemented using IR laser with <100 ns pulse duration but also 15ps with 532nm wavelength
- Dot-Geometry Spacing ≈ 0.5mm → Galvo-scanners limit process speed
- Optimal combination of wafer surface, layer type, aluminium paste an sintering profile needed



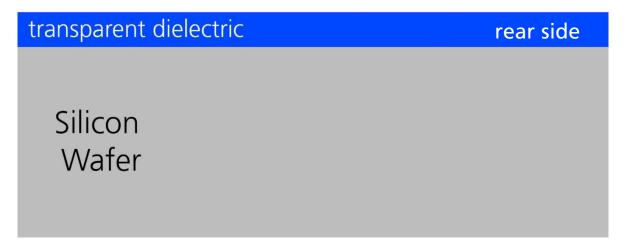
Process flow

Laser Contact Opening (LCO)

For local rear side contacts (p-type PERC)

p-type c-Si wafer

front end processes



not to scale

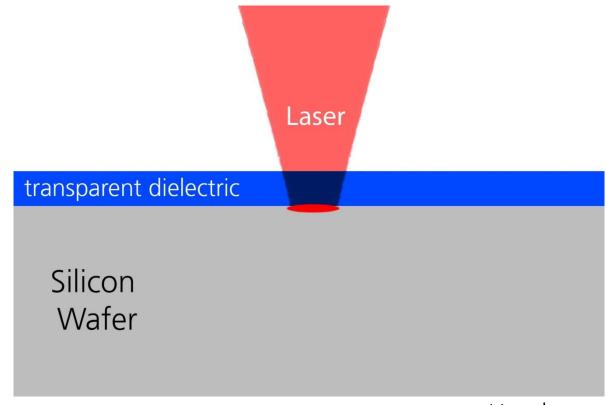


For local rear side contacts (p-type PERC)

p-type c-Si wafer

front end
processes

laser contact
opening (LCO)

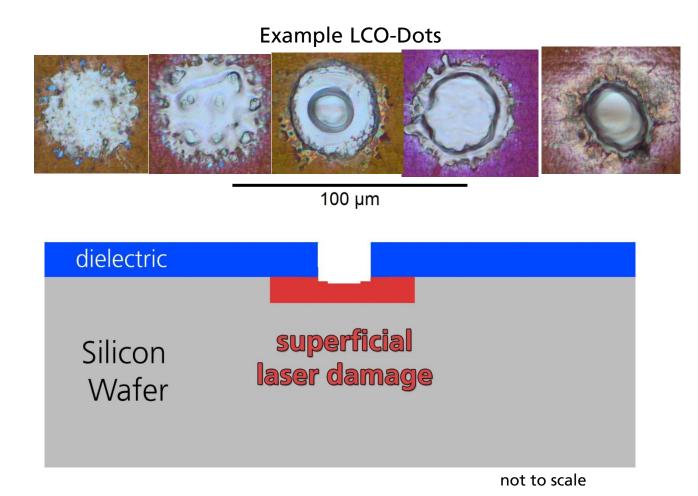


For local rear side contacts (p-type PERC)

p-type c-Si wafer

front end
processes

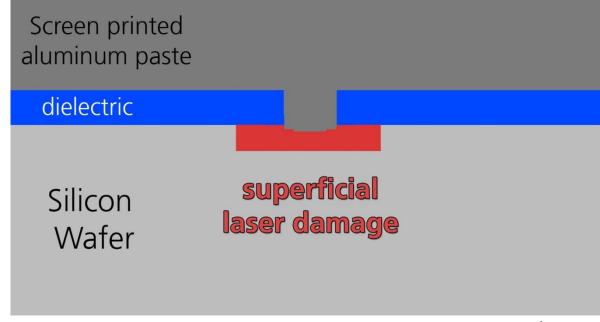
laser contact
opening (LCO)



p-type c-Si wafer

For local rear side contacts (p-type PERC)

laser contact opening (LCO)
screen printing of aluminum paste



not to scale

For local rear side contacts (p-type PERC)

SEM image of final LCO based aluminium contact

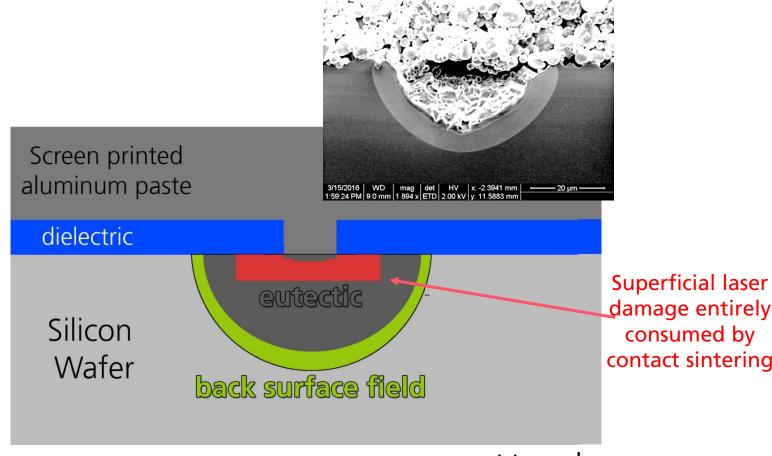
p-type c-Si wafer

front end processes

laser contact opening (LCO)

screen printing of aluminum paste

fast firing process ≈850°C, 5s



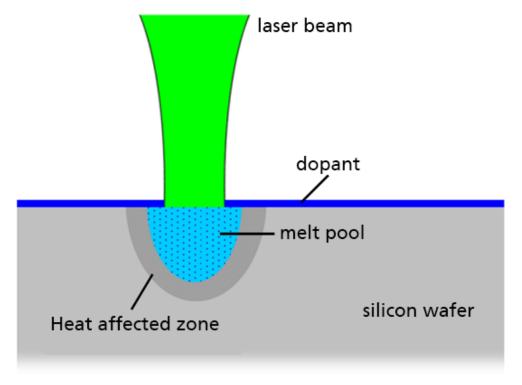
damage entirely consumed by contact sintering

not to scale

Laser Doped Selective Emitter (LDSE)

Overdoping to reduce contact resistance and recombination Laser induced melting to

- Laser induced melting to drive in dopant atoms
- → Is becoming attractive again as front side limits cell performance

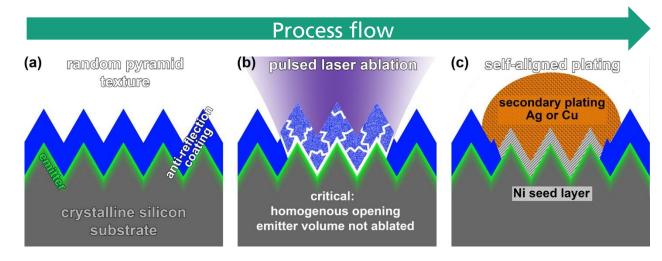


U. Jäger, Dissertation 2012

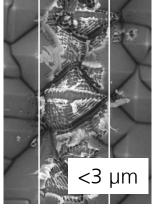
Laser Ablation of Dielectric Layers for Ni-Cu Plated Contacts

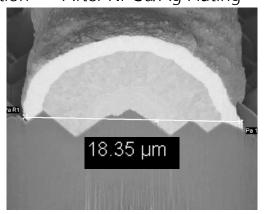
Enabling Silver-free Contacts

- Small contact openings less than 20µm optical width
- Excellent adhesion of plated contacs [1]
- Very small contact resistance on high efficiency emitters [2]
- Typical laser requirements:
 - Ultrashort pulse duration
 - UV wavelength
 - Diffraction limited spot size

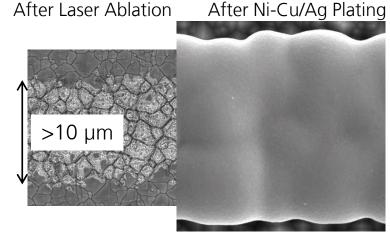


Lab Process After Laser Ablation After Ni-Cu/Ag Plating





Industrial Process





Laser Ablation of Dielectric Layers for Ni-Cu Plated Contacts

Significat Cost Reduction vs Screen-Printing on TOPCon Solar Cells

- Process compatible with both sides
- Ultra shallow laser ablation damage <70nm on TOPCon® allows for cheaper amorphous silicon deposition

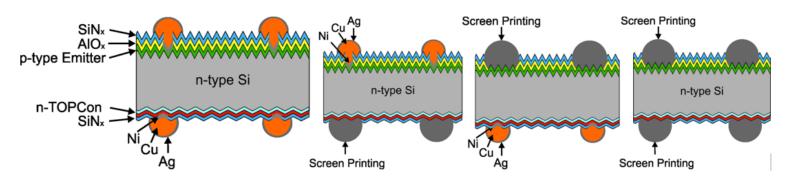
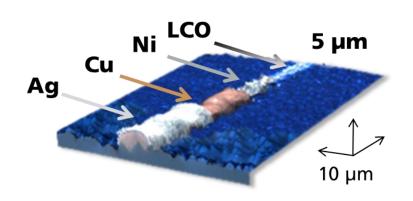
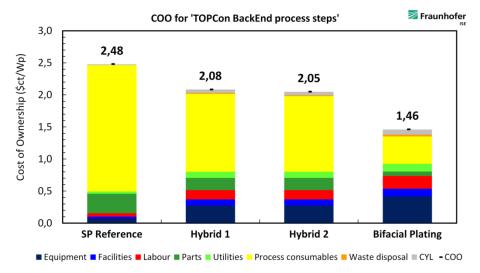
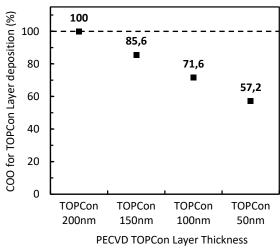


Figure 4 Schematics of i- TOPCon solar cells with bifacially plated Ni/Cu/Ag contacts (left), hybride designs (Hybrid 1 midleft, Hybrid 2 mid-right) of plated or screen printed contacts (right).



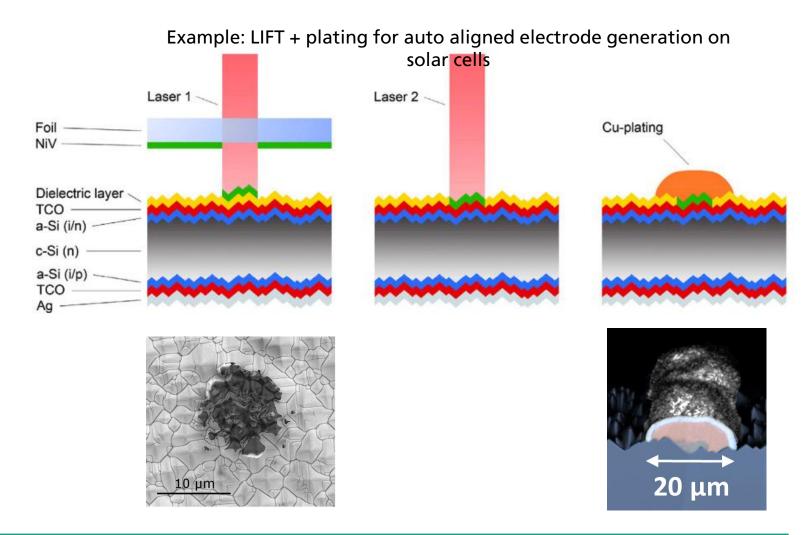




Generative Laser Processes

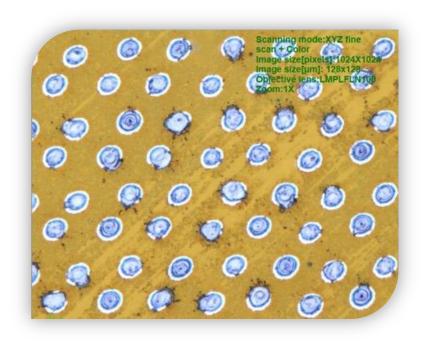
Laser Induced Forward Transfer (LIFT) + Laser Selective Heating (LSH)

- Laser 'Printing' from thin layers on transparent foil
- almost arbitrary choice of materials
- Spot diameters down to a few µm possible at high throughput
- Roll to roll process
- Selective heating & sintering of metal layers

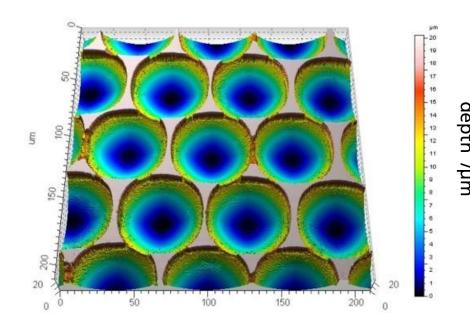


Surface Texturing of Semiconductors

Ablation of Dielectric Layer + Etching



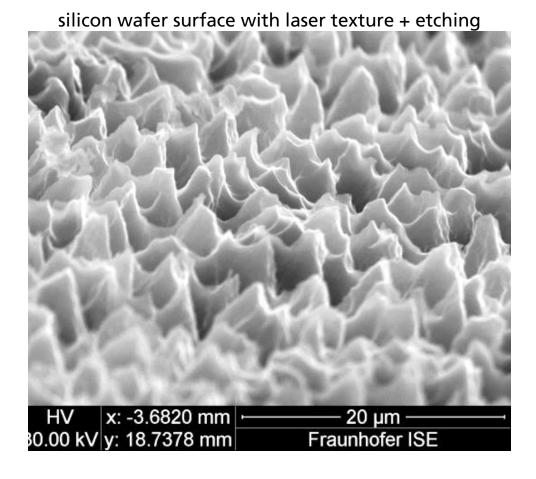




Surface Texturing of Semiconductors

Texturing via direct Ablation (and etching)

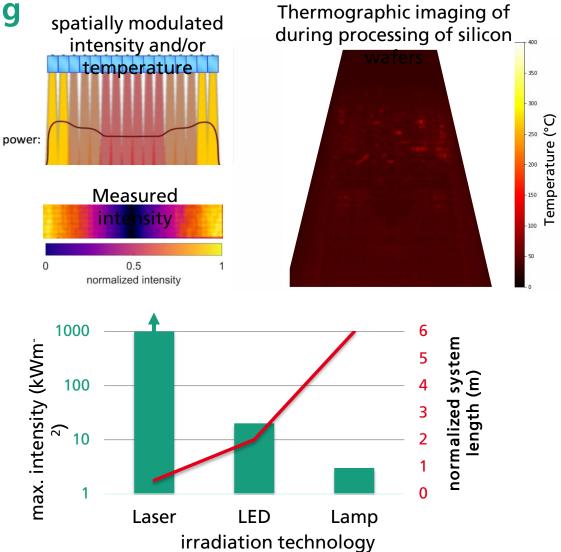
- Achieves very small reflectance <2% for the visible spectrum (silicon) or below depending on material and treatment
- Ultrashort pulse laserablation with large overlap
 → laser-induced periodic surface structures (LIPSS)
- KOH etching



Large Area Inline Laser Irradiation

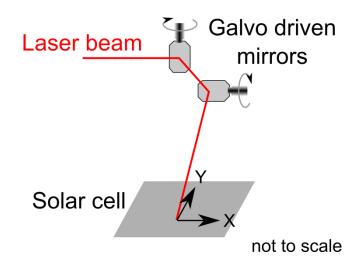
Annealing, Sintering, Defect Engineering

- Smaller Footprint and better energy efficiency compared to competing heating technologies
- Flexibility for either homogeneous illumination or homogeneous temperature distribution
- Rapid temperature processing with ramps up to 400K/s inline and >1000K/s in stationary systems
- Much simpler optical temperature control due to narrow band irradiation
- Maximum temperatures well above comparable technologies
- Potentially replacing RTP and oven systems at much better cost of ownership and process quality



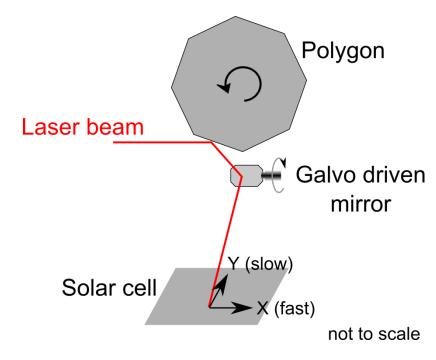
Laser Tools Development

"Ultrafast" Laser Processing Speed



Common galvanometer scanner

Scanning speed for both axis at focal length $\approx 350 \text{mm}$ $v_{\text{scan}} \leq 50 \text{ m/s}$

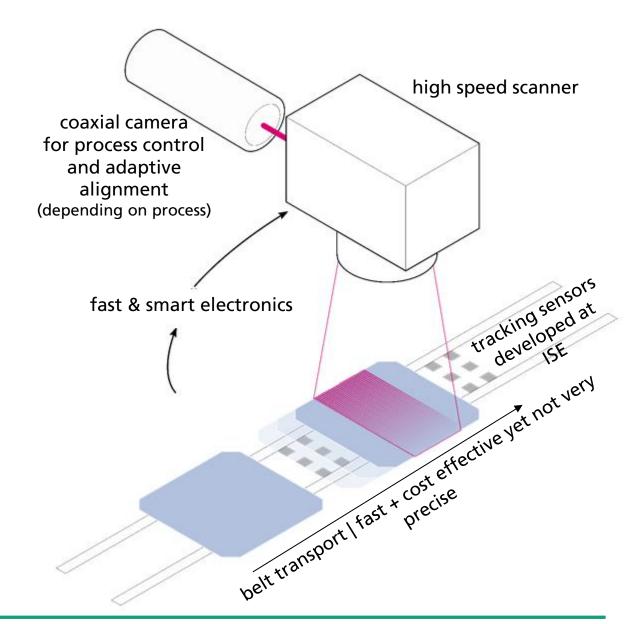


Scanning speed for fast axis at focal length ≈ 350 mm $v_{\text{scan}} \ge 1500 \text{ m/s}$

Laser Tools Development

On the Fly Lasing with High Precision

- Laser beam now often faster than beam delivery or workpiece handling
- Approach: Replacing high accuracy without super heavy and stiff setup
- Fast electronics, sensors and cameras have come down in price significantly
- Potentially higher throughput because stopping is no longer needed



Laser Material Processing for Solar Cell Production

Increasing Lens Requirements

- Wafer size will increase up to 30%
- Minimum required feature sizes will remain the same or go down to 10µm
- → Larger NA f-theta lenses needed depending on process
- Demand for 'perfect' lenses with diffraction limited performance across field of view will go up
- Number of UV processes likely to increase due to material properties

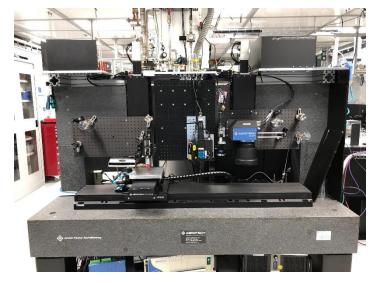


Laser Material Processing Infrastructure & Equipment

Laser-Material-Processing @ Fraunhofer ISE

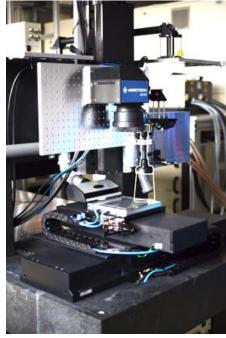
Laboratories & Equipment

> 200m² laser class 4 lab space with XYZ stages and beam delivery up to 1500m/s







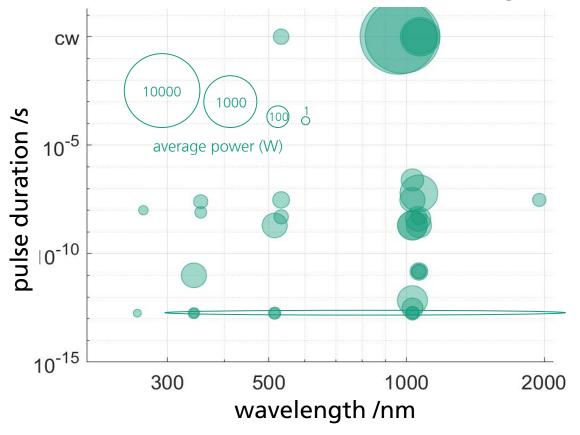


Laser-Material-Processing @ Fraunhofer ISE

Laboratories & Equipment

- > 200m² laser class 4 lab space with XYZ stages and beam delivery up to 1500m/s
- More than laser 25 beam sources for material processing
 - Pulse durations from >180fs to cw
 - Wavelengths from 250nm to 2000nm
 - Average power 1W to >10kW

laser beam sources for material processing @ISE



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Laboratories & Equipment

- > 200m² laser class 4 lab space with XYZ stages and beam delivery up to 1500m/s
- More than laser 25 beam sources for material processing
 - Pulse durations from >180fs to cw
 - Wavelengths from 250nm to 3000nm
 - Average power 1W to >10kW
- Laser class 1 processing machines from prototypes to fully automated production class tools

Keep in mind: several thousand square meters of laboratory with pre- and postprocessing and characterization of solar cells, fuel cells and other devices related to solar energy systems







Great News – New Production of High-End Solar Cells in Europe



"Meyer Burger Technology Ltd aims to transform itself from a supplier of production equipment to a technologically leading manufacturer of solar cells and modules...

. . .

establishing an own large-scale cell and module production in Germany"

19.06.2020

www.meyerburger.com

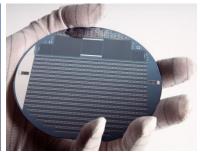
Thank you for your Attention!













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